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FDS5670

FAIRCHILD SEMICONDUCTOR

FDS5670 60V N-Channel PowerTrench[™] MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable $R_{\text{DS}(\text{ON})}$ specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

Features

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• 10 A, 60 V. R_{DS(ON)} = 0.014 \Omega @ V_{GS} = 10 V
R_{DS(ON)} = 0.017 \Omega @ V_{GS} = 6 V.
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- Low gate charge.
- Fast switching speed.
- High performance trench technology for extremely low $R_{_{DS(ON)}}.$
- High power and current handling capability.





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		60	V
V _{GSS}	Gate-Source Voltage		±20	V
ID	Drain Current - Continuous	(Note 1a)	10	A
	- Pulsed		50	
PD	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{_{\!\!\!\!\!\!\Theta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
$R_{_{\!$	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDS5670	FDS5670	13"	12mm	2500 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics				1	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	60			V
Δ <u>BV_{DSS}</u> ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		58		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 V, V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	2.4	4	V
<u>ΔV_{GS(th)}</u> ΔT _J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		6.8		mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance			0.012 0.019 0.014	0.014 0.027 0.017	Ω
D(on)	On-State Drain Current	$V_{GS} = 10 \text{ V}, \text{ V}_{DS} = 5 \text{ V}$	25			A
JFS	Forward Transconductance	$V_{DS} = 5 V, I_D = 10 A$		39		S
Dvnamio	Characteristics	•				
Ciss	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V$		2900		pF
Coss	Output Capacitance	f = 1.0 MHz		685		pF
Crss	Reverse Transfer Capacitance	1		180		pF
Switchir	g Characteristics (Note 2)					
d(on)	Turn-On Delay Time	$V_{DD} = 30 V, I_D = 1 A$		16	29	ns
r	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		10	20	ns
d(off)	Turn-Off Delay Time	1		50	80	ns
f	Turn-Off Fall Time			23	42	ns
Q _a	Total Gate Charge	V _{DS} = 20 V, I _D = 10 A		49	70	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V,		9		nC
Q _{gd}	Gate-Drain Charge			10.4		nC
-	Durce Diode Characteristics an	d Maximum Patings				
	Maximum Continuous Drain-Source Did				2.1	A
Vsp	Drain-Source Diode Forward Voltage	$V_{GS} = 0$ V. Is = 2.1 A (Note 2)		0.72	1.2	V
	Maximum Continuous Drain-Source Did Drain-Source Dide Forward Voltage um of the junction-to-case and case-to-ambient thermal ret R _{0JC} is guaranteed by design while R _{0JA} is determin a) 50° C/W when mounted on a 0.5 in ² pad of 2 oz. copper.	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.1 \text{ A}$ (Note 2) sistance where the case thermal reference is define and by the user's board design.	ed as the sc	, р с) 12	1.2	n

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Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width $\leq 300~\mu s,~\text{Duty}~\text{Cycle} \leq 2.0\%$



FDS5670 Rev. B

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